

The Electrical Impedance Image Reconstruction Using COMSOL MULTIPHYSICS

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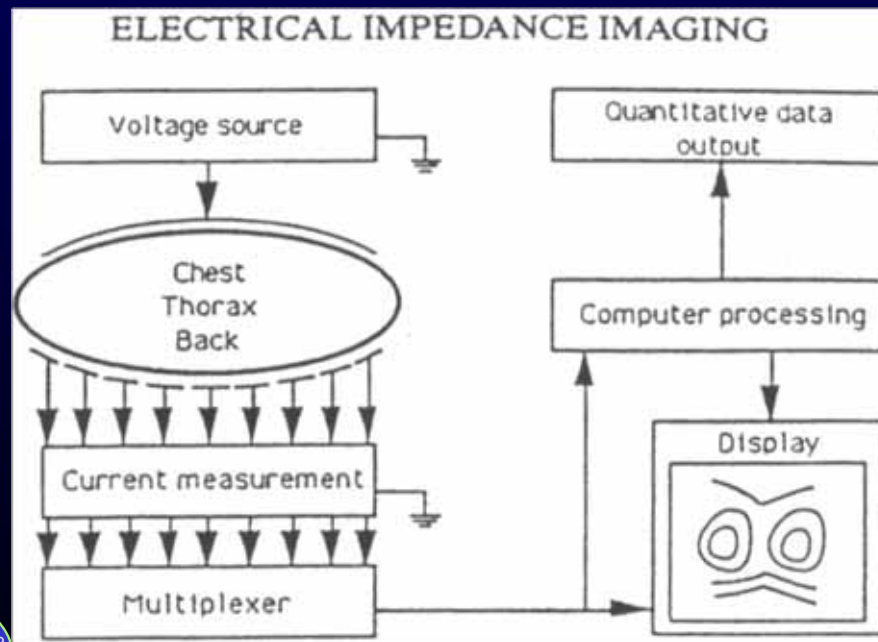
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BME, NCKU

INTRODUCTION

- Swanson(1976) proposed the first frontal plane impedance image technique
- Henderson and Webster (1978) designed the impedance camera

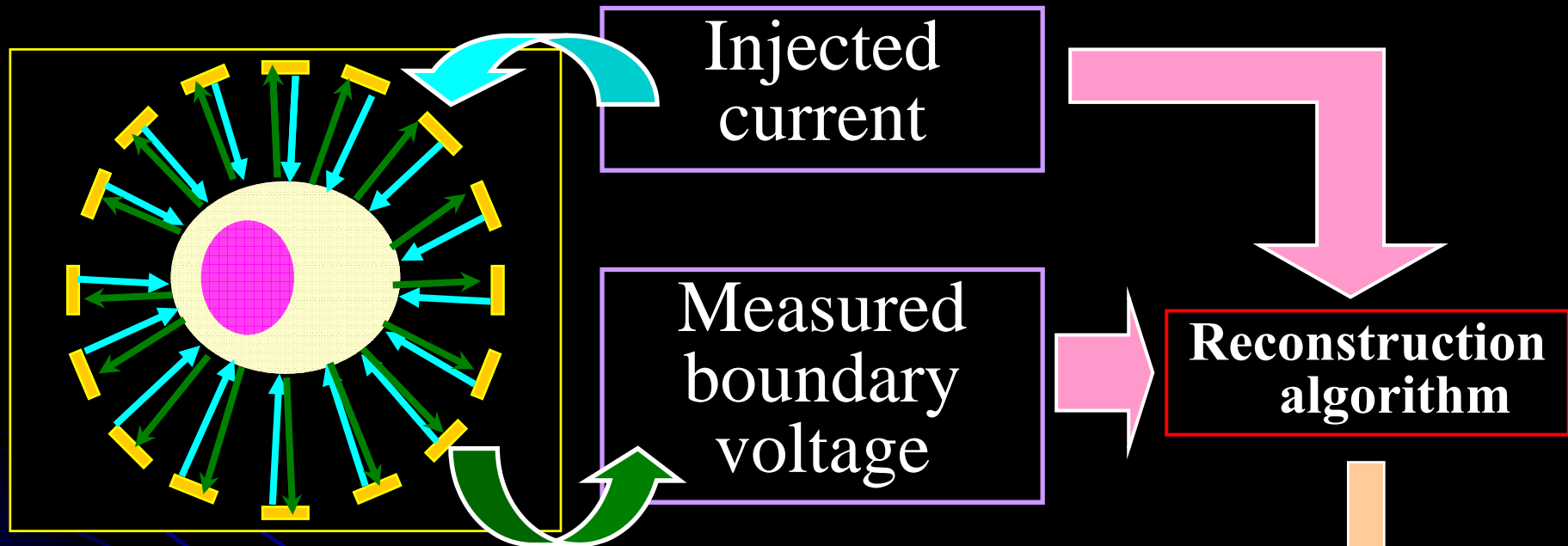


J. G. Webster, electrical impedance tomography, New York: Adam Higler, pp 3-4, 1990.



INTRODUCTION

Electrical Impedance Tomography




Advantages:

- Non-invasive imaging
- Low cost system
- No radiation hazard
- Long term monitoring

Problem Description

- **Current pattern** plays an important role in EIT. It may affect
 - Spatial resolution
 - Computation complexity
- Information needed for **image reconstruction**
 - The applied current pattern
 - The measured boundary voltage pattern

- Current patterns
 - Adjacent-pair current patterns
 - Opposite-pair current patterns
 - Trigonometric current patterns
 - Reconstruction algorithms
 - NOSER
 - Backprojection
- 

EIT4 (BME, NCKU)

	Specification	
Data Acquisition	Number of electrodes	32
	Carrier frequency	<i>Multi-Frequency</i> 1 kHz-1 MHz
	Current channels	32
	Voltage channels	1
	Measurement method	2-electrode, differential mode
	Resolution	16 bits
	Current pattern	<i>Sinusoidal current patterns</i>
	Sampling rate	500 kHz
Forward solver	FEM	
Inverse solver	<i>Backprojection</i>	
Image type	<i>Dynamic</i>	

RESEARCH FRAMEWORK

DSP-based
electrical impedance
image
reconstruction

```
graph TD; A["DSP-based electrical impedance image reconstruction"] --> B["Equi-potential lines computation"]; A --> C["Filter backprojection algorithm"]; A --> D["DSP implementation & System testing"];
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Equi-potential lines
computation

Filter backprojection
algorithm

DSP implementation
&
System testing

**Equi-potential lines
computation**

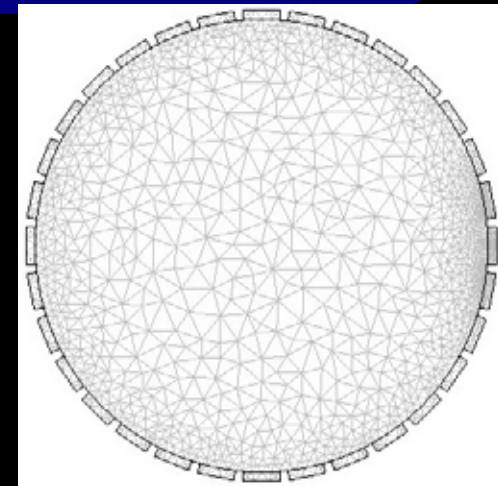
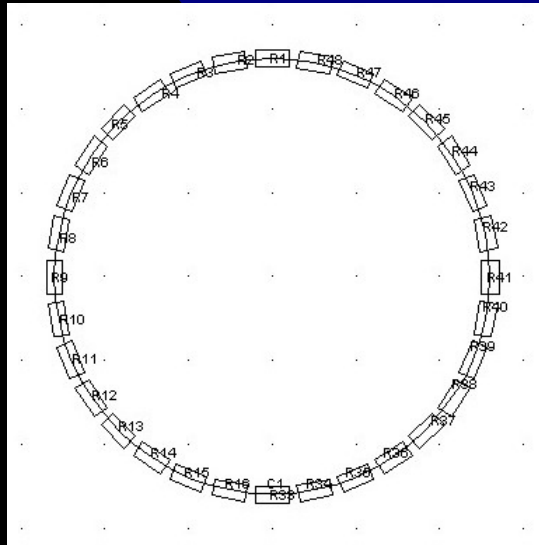


**Filter Backprojection
Algorithm**



**DSP implementation
&
System testing**

1. To design torso model
2. To build FEM model using COMSOL
3. To apply current patterns
4. To compute voltages
5. To find the equi-potential lines



**Equi-potential lines
computation**



**Filter Backprojection
Algorithm**



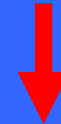
**DSP implementation
&
System testing**

Inverse problem

Given boundary voltage V_n
And boundary current density J_n



Inverse solver



Find the internal resistivity
Distribution

**Equi-potential lines
computation**



**Filter Backprojection
Algorithm**



**DSP implementation
&
System testing**



- TMS320C6713
 - 32-bit command/cycle
 - High efficiency
 - Floating point
- High speed

**Equi-potential lines
computation**



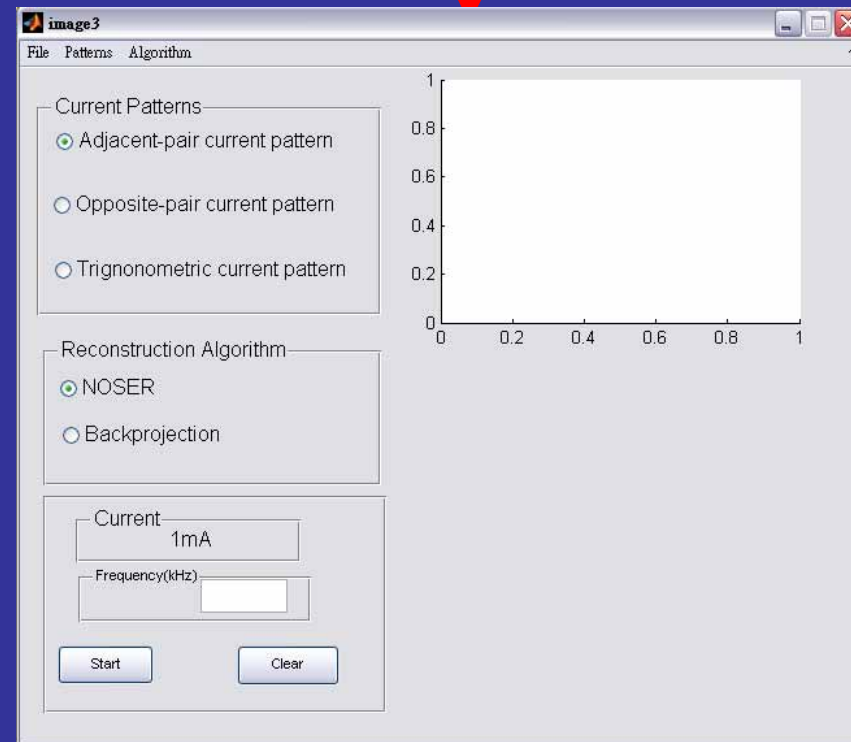
**Filter Backprojection
Algorithm**



**DSP implementation
&
System testing**



JTAG



METHODS & MATERIALS

- Finite Element Method in EIT

- The governing equations

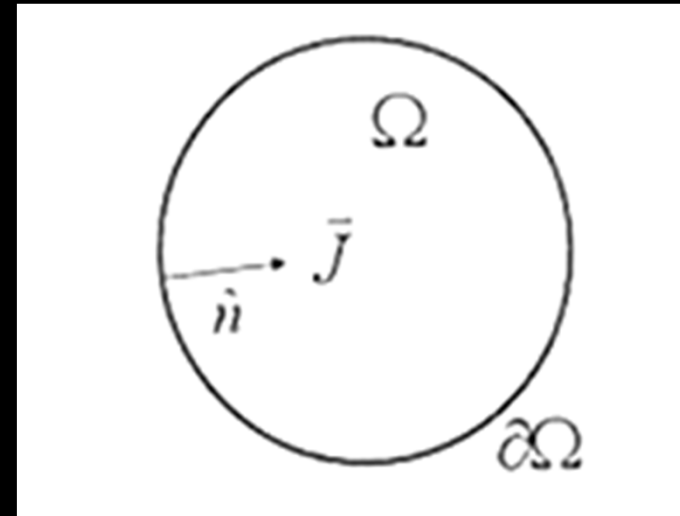
$$\nabla \cdot \vec{J} = 0 \quad \vec{J} = \sigma \vec{E}$$

$$\vec{E} = -\nabla U$$

$$\Rightarrow \nabla^2 U = 0 \quad \text{with} \quad \vec{J} \cdot \hat{n} = -\sigma_0 \frac{\partial U}{\partial n} = -j$$

- In a polar coordinate system

$$\frac{1}{r} \frac{\partial}{\partial r} \left(r \frac{\partial}{\partial r} \right) + \frac{1}{r^2} \frac{\partial^2}{\partial \theta^2} = 0 \quad \& \quad \sigma_0 \frac{\partial U}{\partial r} = j$$



\vec{J} : current density

\vec{E} : electric field

σ : conductivity

\hat{n} : outward unit normal vector

➤ Boundary conditions

Dirichlet condition: $U = U_0$ on $\partial\Omega$

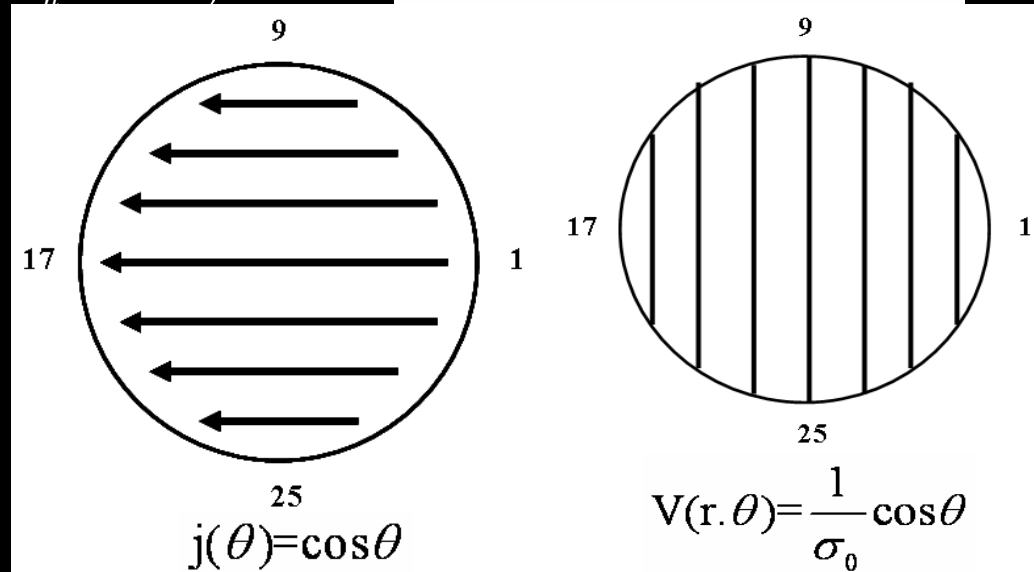
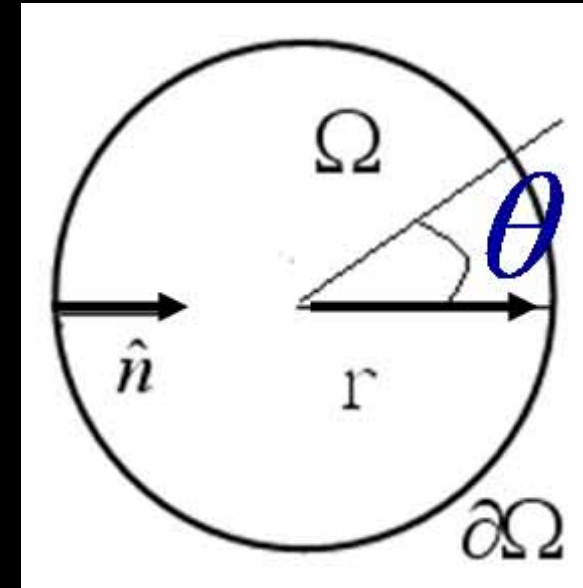
Neumann condition: $\sigma_0 \frac{\partial U}{\partial n} = j$ on $\partial\Omega$

$$U(r, \theta) = \frac{r_0}{\sigma_0} \sum_{n=1}^{\infty} \frac{1}{n} \left(\frac{r}{r_0} \right)^n (C_n \cos n\theta + S_n \sin n\theta)$$

$$\vec{J}(\theta) = \cos \theta$$

• Let $r = r_0$, $n = 1$

$$\Rightarrow U(r, \theta) = \frac{1}{\sigma_0} \cos \theta$$



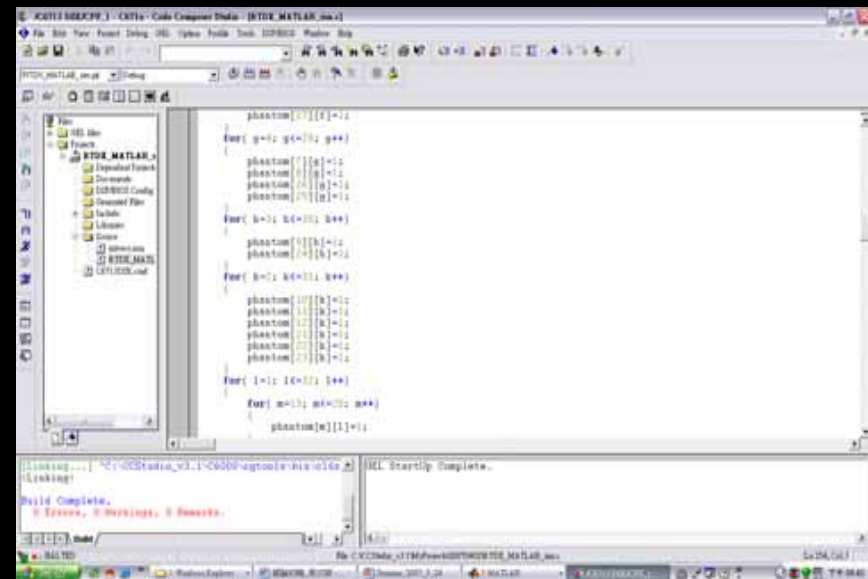
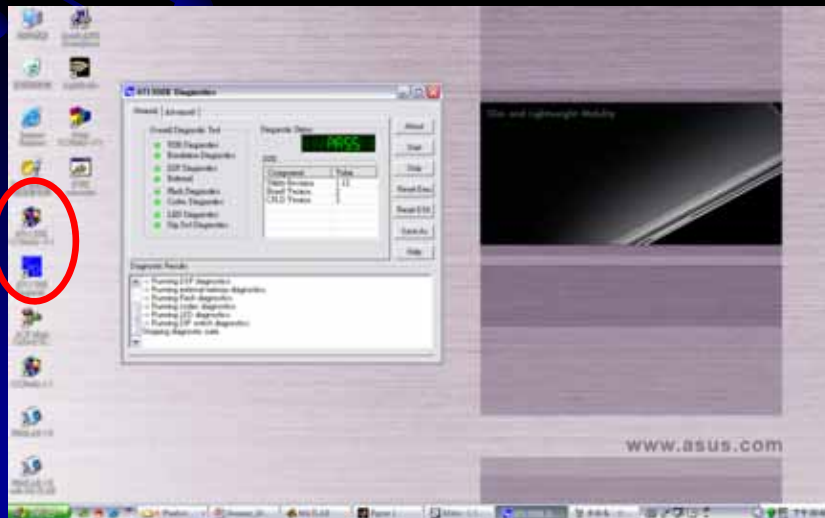
n : spatial frequency

σ : conductivity

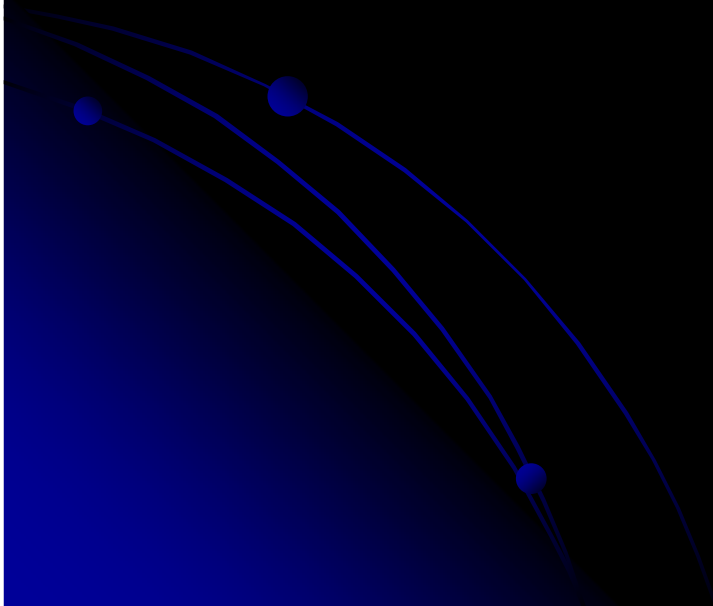
\hat{n} : outward unit normal vector

METHODS & MATERIALS

- TI C6713 DSK
 - DSP & PC link: 6713 DSK Diagnostics Utility v3.1 (USB)
 - Developmental surrounding: CCStudio 3.1
 - Language: C Langue
 - Compiler: CCStudio 3.1



RESULTS & DISCUSSIONS

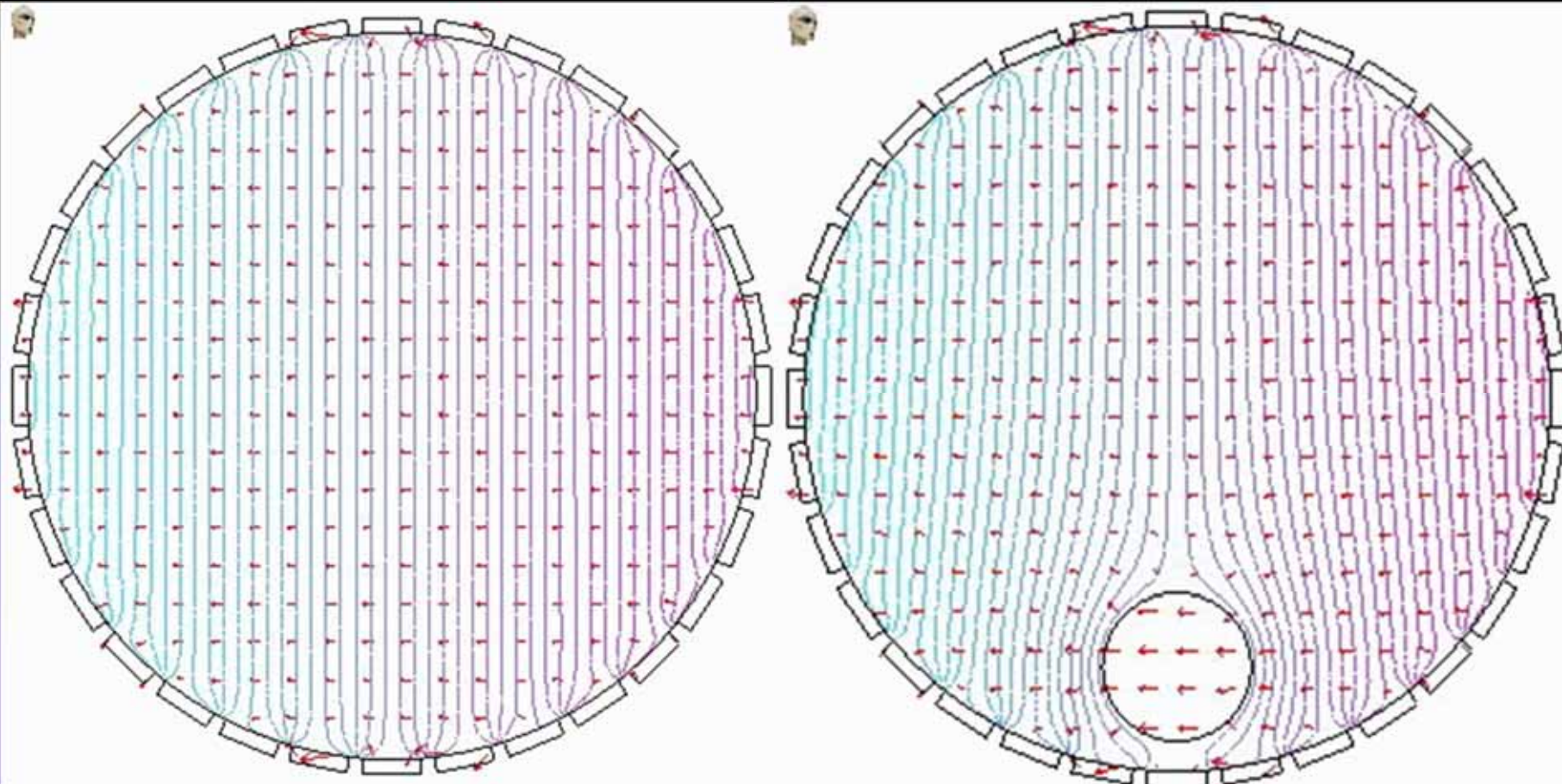


SINUSOIDAL CURRENT PATTERN SIMULATION

- Equi-potential lines computation with COMSOL

Homogenous

Non-homogenous

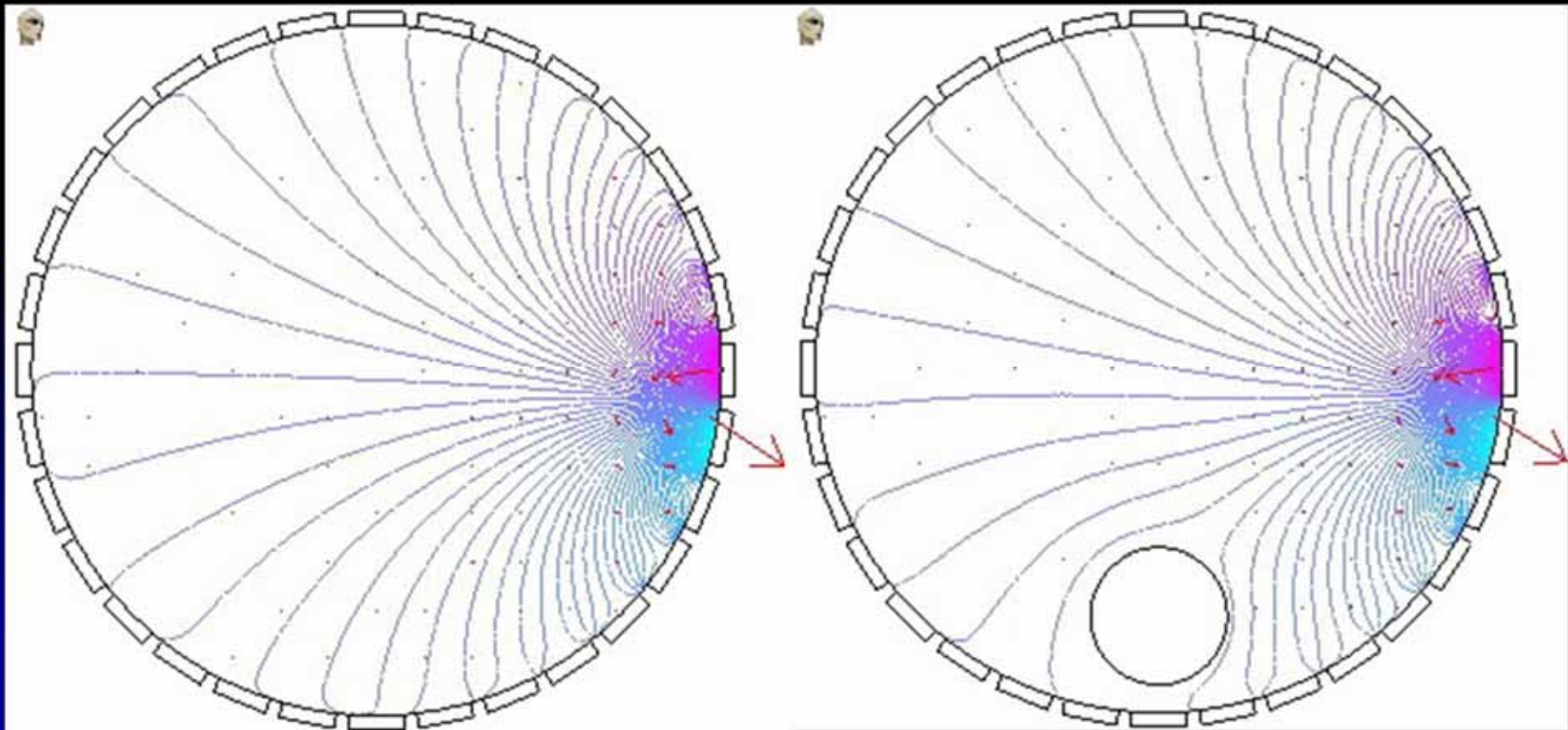


SINUSOIDAL CURRENT PATTERN SIMULATION

- Equi-potential lines computation with COMSOL

Homogenous

Non-homogenous



- Verification

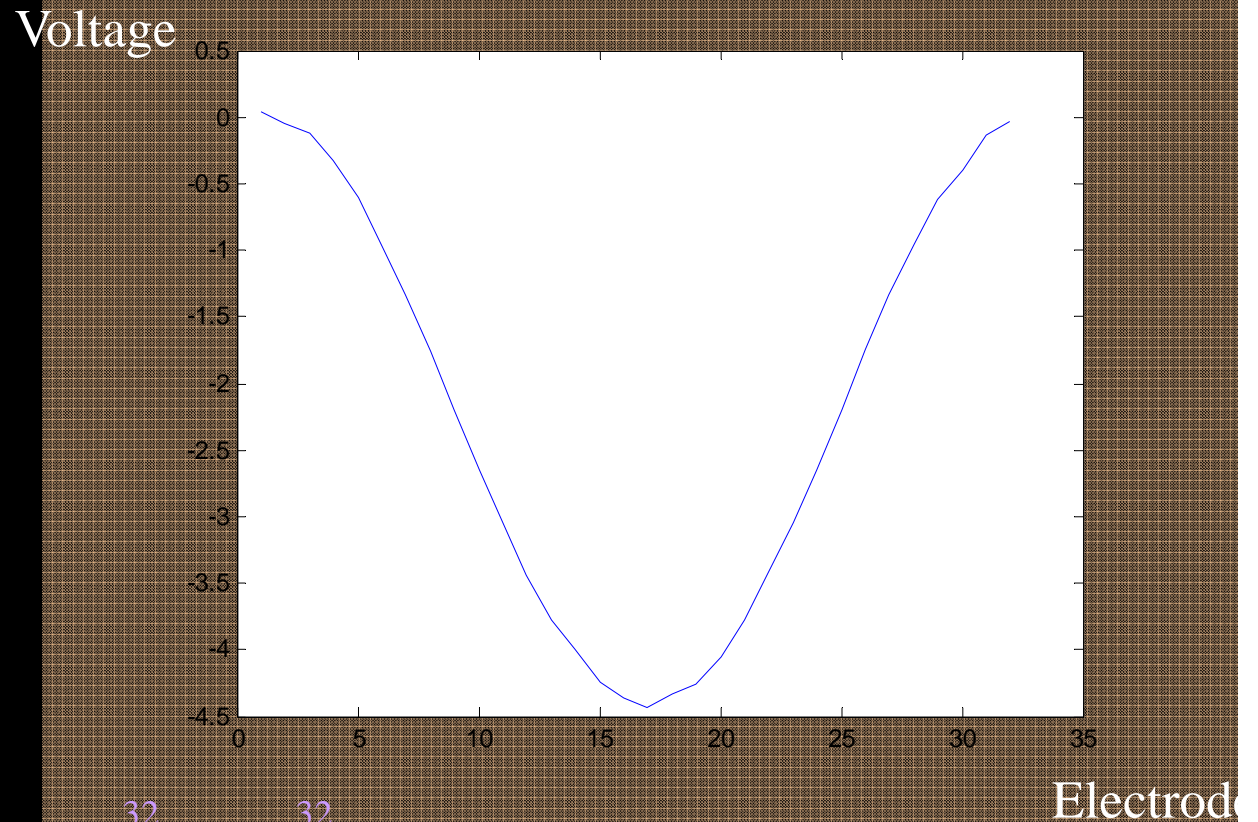
$$\sum_{i=1}^{32} V_i = 0$$

$$\Rightarrow V_{32} = \sum_{i=1}^{31} V_i$$

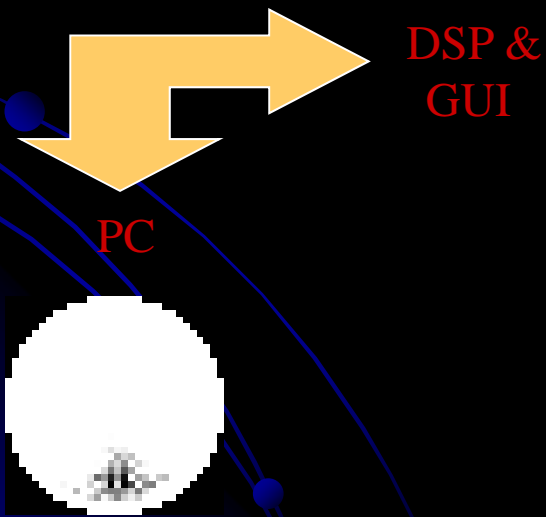
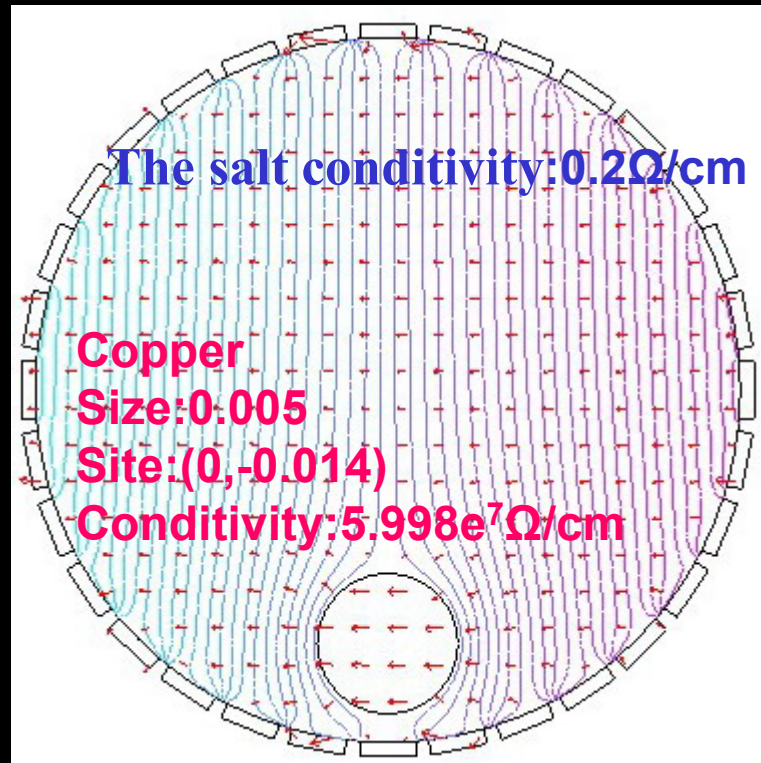
$$\Rightarrow \sum_{i=1}^{32} V_i^m = \sum_{i=1}^{32} (V_i - V_{32}) = \sum_{i=1}^{32} V_i - \sum_{i=1}^{32} V_{32} = 0 - 32 \times V_{32}$$

$$\therefore V_i = V_i^m + V_{32}$$

l: electrode
m: rotation



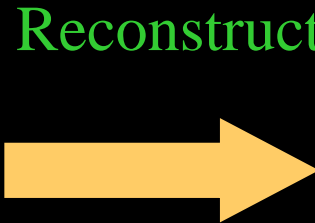
SIMULATION & RECONSTRUCTION



	Value(1,;)	Value(2,;)	Value(3,;)
1	0.063826030...	-0.01788890...	-0.07137704
2	-3.27821E-10	-0.00725380...	0.027381449
3	-0.14805436...	-0.06987867...	0.050592349
4	0.26974234	0.21721870	5.50032E-1

Sinusoidal Current Patterns

Copper
Size:0.01
Site:(0.002,0.012)
Conditivity: $5.998e^7 \Omega/\text{cm}$
The salt conditivy: $0.2 \Omega/\text{cm}$

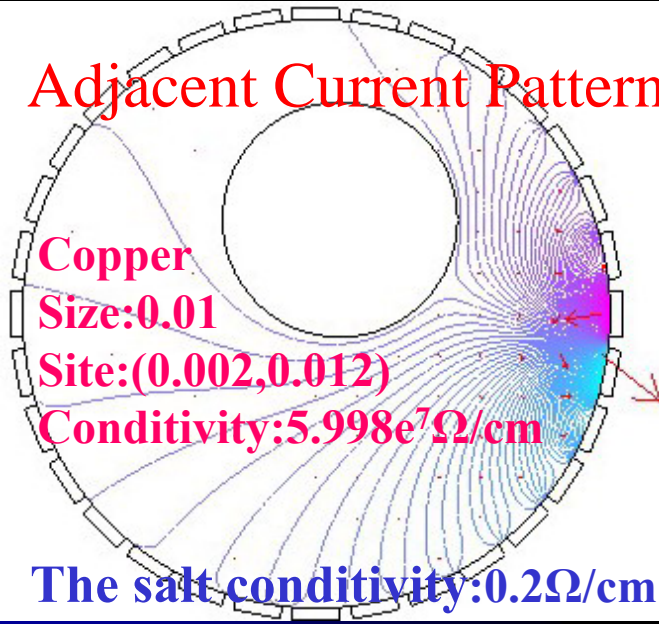


Reconstruction

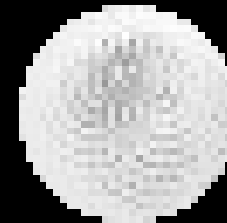
	Value(1,;)	Value(2,;)	Value(3,;)
1	-0.032474857	-0.203143487	-0.35442436
2	-3.25939E-10	-0.106972654	-0.18960263
3	-0.031437549	-0.060905986	-0.07365584
4	0.114919914	0.073739310	0.22511E-4

Adjacent Current Patterns

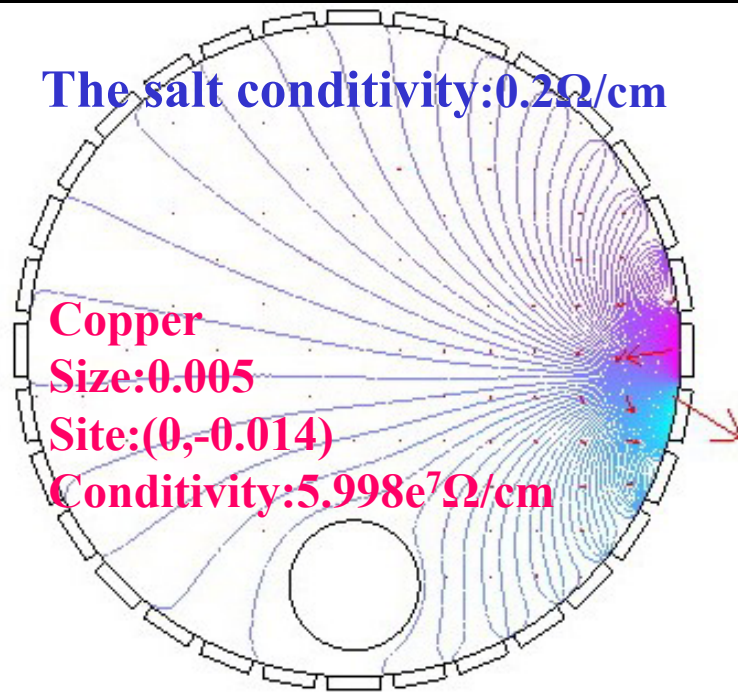
Copper
Size:0.01
Site:(0.002,0.012)
Conditivity: $5.998e^7 \Omega/\text{cm}$
The salt conditivy: $0.2 \Omega/\text{cm}$



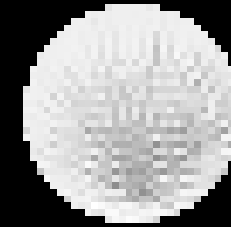
Reconstruction



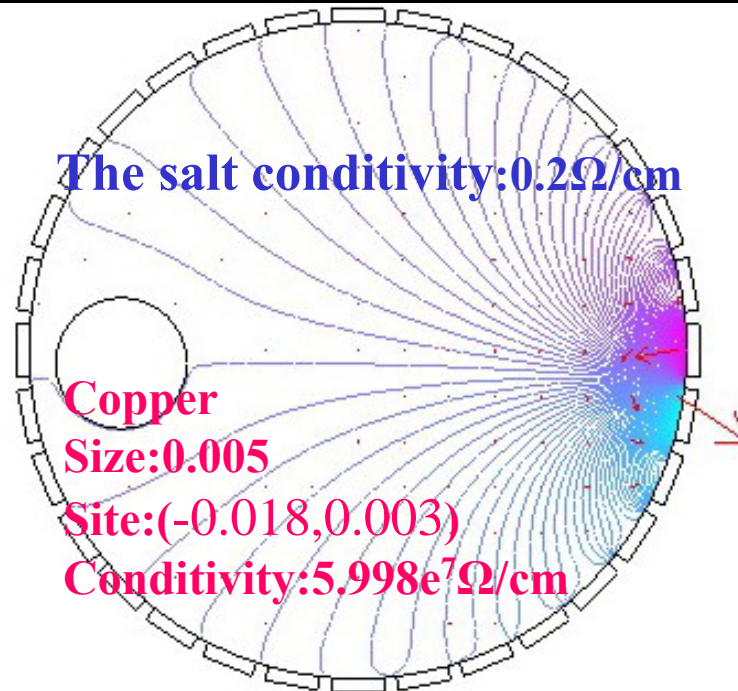
The salt conductivity: $0.2\Omega/\text{cm}$



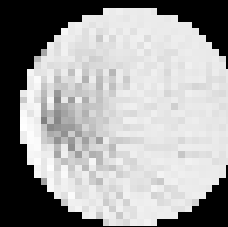
Reconstruction

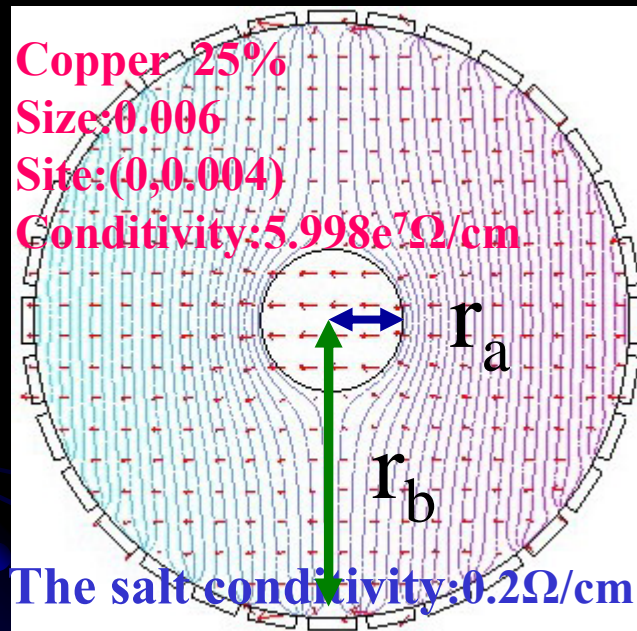


The salt conductivity: $0.2\Omega/\text{cm}$



Reconstruction





- Spatial resolution = r_a/r_b
 - Sinusoidal current pattern Spatial resolution = 0.25
 - Adjacent-pair current pattern Spatial resolution = 0.45

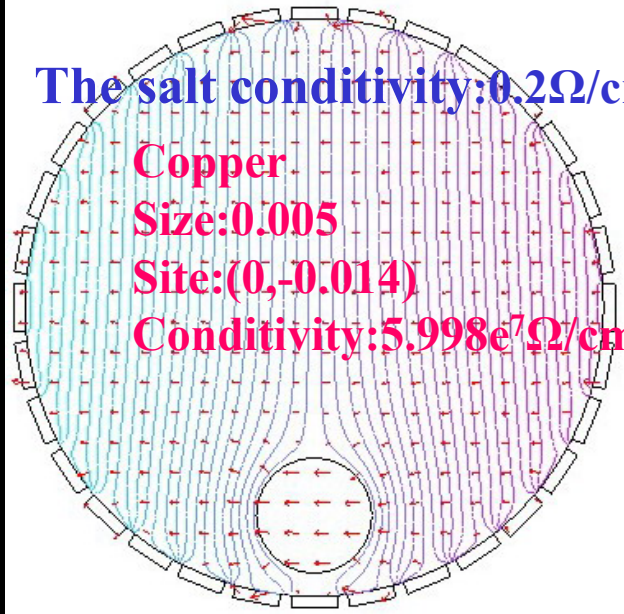
The salt conductivity: $0.2 \Omega/\text{cm}$

Copper

Size: 0.005

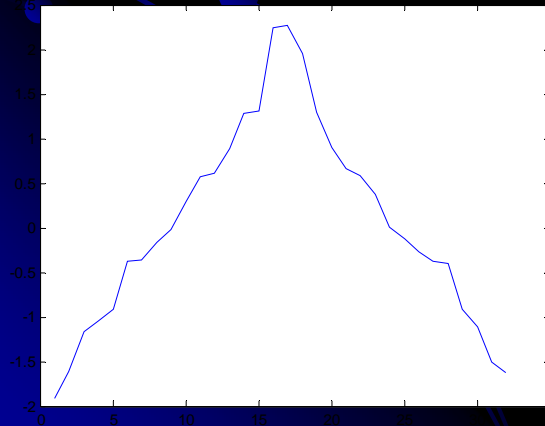
Site: (0, -0.014)

Conductivity: $5.998 \times 10^7 \Omega/\text{cm}$



Reconstruction

+ Noise
Error: $\pm 1\%$



Verification

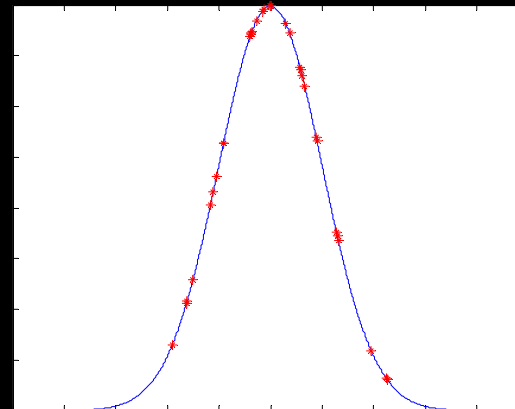


image3
File Patterns Algorithm

Current Patterns

- Adjacent-pair current pattern
- Opposite-pair current pattern
- Trigonometric current pattern

Reconstruction Algorithm

- NOSER
- Backprojection

Current: 1mA

Frequency(kHz): 500

Start Clear

	Value(1,;)	Value(2,;)	Value(3,;)
1	0.064	-0.018	-0.07
2	-0.0	-0.0070	0.02
3	-0.148	-0.07	0.05
4	0.360	0.017	0

CONCLUSION

- Sinusoidal current pattern is better than adjacent current patterns in resolution.
- The image reconstruction time needed for the sinusoidal current pattern is the same as the adjacent current pattern.
- DSP based impedance image reconstruction system works well in the simulation experiments.

Thanks for your attention

